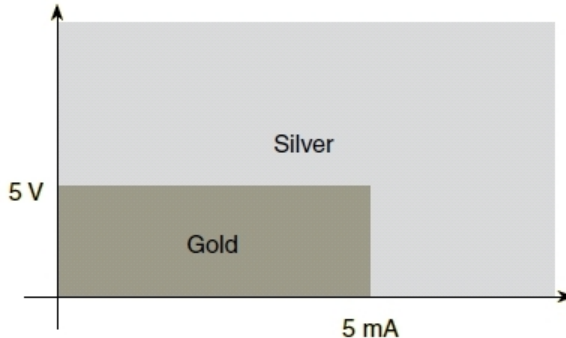
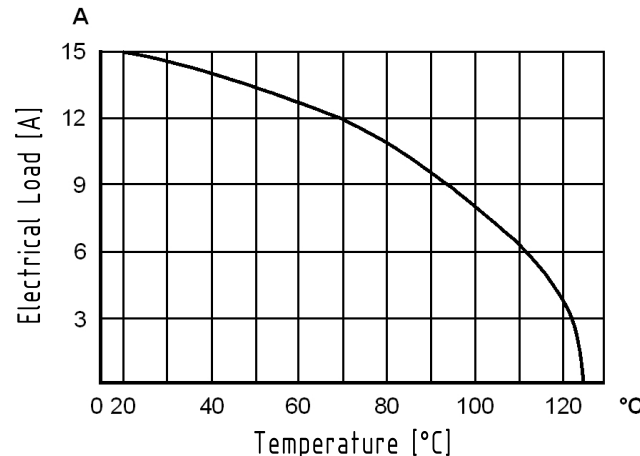
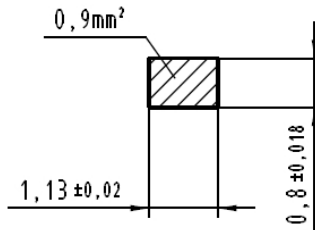


1	2	3	4	5	6	7	8																																																				
A	 DIN power female connector RoHS compliant  			Low currents and voltages Type H standard contacts have a silver plated surface. This precious metal has excellent conductive properties. In the course of a contact's lifetime, the silver surface generates a black oxide layer due to its affinity to sulphur. This layer is smooth and very thin and is partly interrupted when the contacts are mated and unmated, thus guaranteeing very low contact resistances. In the case of very low currents or voltages small changes to the transmitted signal may be encountered. In systems where such a change to the transmitted signal could lead to faulty functions and also in extremely aggressive environments, HARTING recommend the use of gold plated contacts. Below is a table derived from actual experiences.  Soldering instructions The connectors should be protected when being soldered in a dip, flow or film soldering baths. Otherwise, they might become contaminated as a result of soldering operations or deformed as a result of overheating. (1) For prototypes and short runs protect the connectors with an industrial adhesive tape, e.g. Tesaband 4331 (www.tesa.de). Cover the underside of the connector moulding and the adjacent parts of the pcb as well as the open sides of the connector. This will prevent heat and gases of the soldering apparatus from damaging the connector. About 140 + 5 mm of the tape should suffice. (2) For large series a jig is recommended. Its protective cover with a fast action mechanical locking device shields the connectors from gas and heat generated by the soldering apparatus. As an additional protection a foil can be used for covering the parts that should not be soldered.				B																																																			
B	General information <table><tr><td>Design</td><td>IEC 60603-2</td><td>type: H female low profile</td></tr><tr><td>No. of contacts</td><td>15</td><td></td></tr><tr><td>Contact spacing</td><td>5,08 mm / 6,5 mm between the rows</td><td></td></tr><tr><td>Test voltage</td><td>3100 V</td><td></td></tr><tr><td>Contact resistance</td><td>max. 8mOhm</td><td></td></tr><tr><td>Insulation resistance</td><td>min. 10^9Ohm</td><td></td></tr><tr><td>Working current</td><td>15A at 20°C (see derating diagram)</td><td></td></tr><tr><td>Temperature range</td><td>-55°C ... +125°C</td><td></td></tr><tr><td>Termination technology</td><td>solder</td><td></td></tr><tr><td>Clearance</td><td>min. 4,5 mm</td><td></td></tr><tr><td>Creepage</td><td>min. 8,0 mm</td><td></td></tr><tr><td>Insertion and withdrawal force</td><td>15-pole max. 90N</td><td></td></tr><tr><td>Mating cycles</td><td>- PL1 acc. to IEC 60603-2 => - PL2 acc. to IEC 60603-2 => - PL3 acc. to IEC 60603-2 =></td><td>500 mating cycles 400 mating cycles 50 mating cycles</td></tr><tr><td>UL file</td><td>E102079</td><td></td></tr><tr><td>RoHS - compliant</td><td>Yes</td><td></td></tr><tr><td>Leadfree</td><td>Yes</td><td></td></tr><tr><td>Hot plugging</td><td>No</td><td></td></tr></table>			Design	IEC 60603-2	type: H female low profile	No. of contacts	15		Contact spacing	5,08 mm / 6,5 mm between the rows		Test voltage	3100 V		Contact resistance	max. 8mOhm		Insulation resistance	min. 10^9Ohm		Working current	15A at 20°C (see derating diagram)		Temperature range	-55°C ... +125°C		Termination technology	solder		Clearance	min. 4,5 mm		Creepage	min. 8,0 mm		Insertion and withdrawal force	15-pole max. 90N		Mating cycles	- PL1 acc. to IEC 60603-2 => - PL2 acc. to IEC 60603-2 => - PL3 acc. to IEC 60603-2 =>	500 mating cycles 400 mating cycles 50 mating cycles	UL file	E102079		RoHS - compliant	Yes		Leadfree	Yes		Hot plugging	No						C
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